

AON7403 30V P-Channel MOSFET

General Description

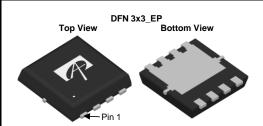
The AON7403 uses advanced trench technology to provide excellent $R_{\rm DS(ON)},$ and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications.

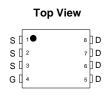
Product Summary

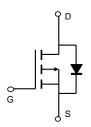
 $\begin{array}{lll} V_{DS} & -30V \\ I_{D} \; (at \; V_{GS} \!\!=\!\! -10V) & -29A \\ R_{DS(ON)} \; (at \; V_{GS} \!\!=\!\! -10V) & < 18 m\Omega \\ R_{DS(ON)} \; (at \; V_{GS} \!\!=\!\! -5V) & < 36 m\Omega \end{array}$

100% UIS Tested









Absolute Maximum Ra	- (! T - O.E.)		(1
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Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	-30	V	
Gate-Source Voltage		V_{GS}	±25	V	
Continuous Drain	T _C =25°C		-29		
Current	T _C =100°C	'D	-18	A	
Pulsed Drain Current ^C		I _{DM}	-80		
Continuous Drain	T _A =25°C		-11	A	
Current	T _A =70°C	IDSM	-8.5	A	
Avalanche Current ^C		I _{AR}	24	A	
Repetitive avalanche energy L=0.1mH ^C		E _{AR}	29	mJ	
	T _C =25°C	В	25	W	
Power Dissipation ^B	T _C =100°C	P _D	10	VV	
	T _A =25°C	В	4.1	W	
Power Dissipation A	T _A =70°C	P _{DSM}	2.6	VV	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics					
Parameter		Symbol	Тур	Max	Units
Maximum Junction-to-Ambient A	t ≤ 10s	D	22	30	°C/W
Maximum Junction-to-Ambient AD	Steady-State	$R_{\theta JA}$	47	60	°C/W
Maximum Junction-to-Lead	Steady-State	$R_{\theta JC}$	4.2	5	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC P	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V
I _{DSS}	I _{DSS} Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V			-1	μА
יטאטי	Zero Gate Voltage Brain Gurrent	T _J =55°C	;		-5	μΑ
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±25V			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$	-1.7	-2.2	-3	V
$I_{D(ON)}$	On state drain current	V _{GS} =-10V, V _{DS} =-5V	-80			Α
		V _{GS} =-10V, I _D =-8A		14	18	mΩ
R _{DS(ON)}	Static Drain-Source On-Resistance	T _J =125°C	;	20	25	1117.5
		V _{GS} =-5V, I _D =-5A		26	36	mΩ
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-8A		20		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.7	-1	V
Is	Maximum Body-Diode Continuous Current				-22	Α
DYNAMIC	PARAMETERS					
C_{iss}	Input Capacitance			1130	1400	pF
Coss	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		240		pF
C_{rss}	Reverse Transfer Capacitance			155		pF
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz		5.8	8	Ω
SWITCHI	NG PARAMETERS					
$Q_g(10V)$	Total Gate Charge			18	24	nC
Q_{gs}	Gate Source Charge	V_{GS} =-10V, V_{DS} =-15V, I_{D} =-8A		5.5		nC
Q_{gd}	Gate Drain Charge			3.3		nC
t _{D(on)}	Turn-On DelayTime			8.7		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =1.8 Ω ,		8.5		ns
$t_{D(off)}$	Turn-Off DelayTime	$R_{GEN}=3\Omega$		18		ns
t _f	Turn-Off Fall Time			7		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-8A, dI/dt=500A/μs		12	16	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =-8A, dI/dt=500A/μs		26		nC

A. The value of R_{BIA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The Power dissipation P_{DSM} is based on R $_{0.JA}$ t \leq 10s value and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design, and the maximum temperature of 150° C may be used if the PCB allows it.

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B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150° C. Ratings are based on low frequency and duty cycles to keep initial $T_J = 25^{\circ}$ C.

D. The R_{0,0,A} is the sum of the thermal impedence from junction to case R_{0,0} and case to ambient.

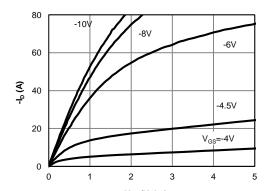
E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

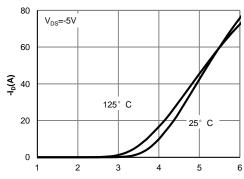
G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C.

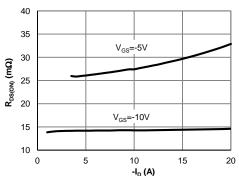
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



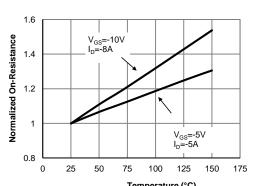
-V_{DS} (Volts) Fig 1: On-Region Characteristics (Note E)



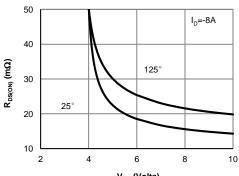
-V_{GS}(Volts)
Figure 2: Transfer Characteristics (Note E)



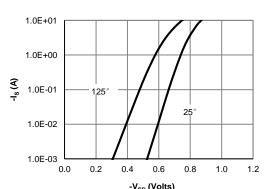
-I_D (A)
Figure 3: On-Resistance vs. Drain Current and Gate
Voltage (Note E)



Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature (Note E)

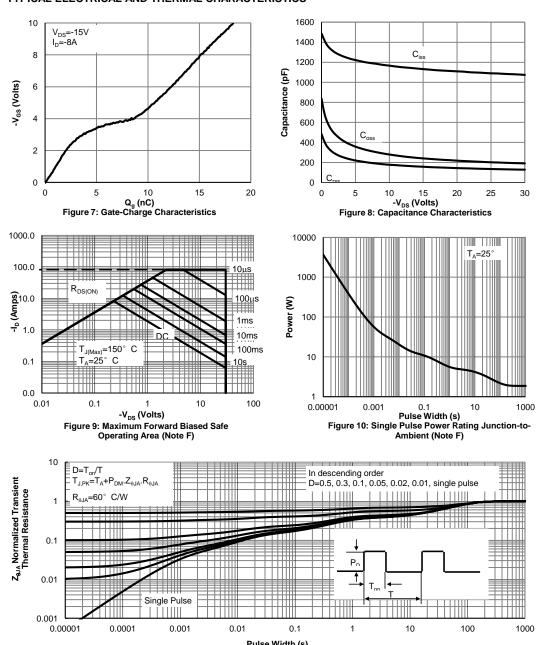


-V_{GS} (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage
(Note E)



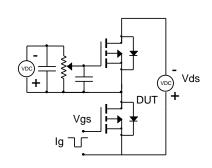
-V_{SD} (Volts) Figure 6: Body-Diode Characteristics (Note E)

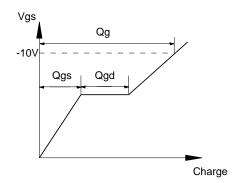
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



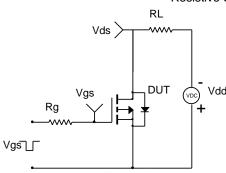
Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

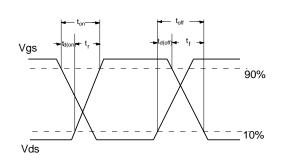
Gate Charge Test Circuit & Waveform



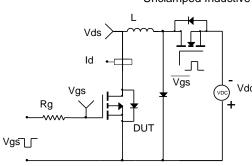


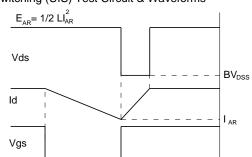
Resistive Switching Test Circuit & Waveforms



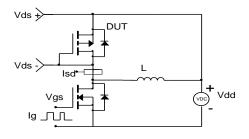


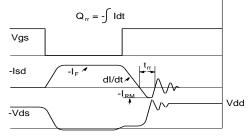
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





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